

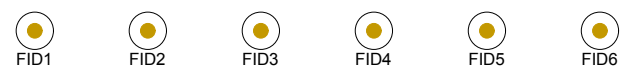
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PCB: PMP7935
PMP87935

PCB LOGO
Texas Instruments



LBL1
PCB Label
Size: 0.65" x 0.20 "

ZZ1
Label Assembly Note
This Assembly Note is for PCB labels only

ZZ2
Assembly Note
These assemblies are ESD sensitive, ESD precautions shall be observed.

ZZ3
Assembly Note
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ4
Assembly Note
These assemblies must comply with workmanship standards IPC-A-610 Class 2., unless otherwise specified.

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Designed for: Public Release		Mod. Date: 5/21/2015	
Project Title: LM27403 Buck			
Number: PMP8000	Rev: A	Sheet Title: Hardware	
SVN Rev: Version control disabled		Assembly Variant: 001	Sheet: 2 of 2
Drawn By: Robert Sheehan		File: PMP8000_REVA_Sh2_SchDoc	Size: B
Engineer: Robert Sheehan		Contact: http://www.ti.com/support	



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